IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: KIM, Sangyum; CHOI, Chang Hee; JO, Cha Jae; KIM, Jeong Ik; WOO, Kyung Nyung; KI, Joon Seo; MOON, Hong Gi

SERIAL NO.:

FILED:

Herewith

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS

ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER FOIL

MANUFACTURED THEREBY

REMARKS ON PRELIMINARY AMENDMENT

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450 Sir:

In this preliminary amendment, please consider the following remarks in conjunction with the amendments to the above-identified application as follows:

REMARKS

The present Preliminary Amendment has been entered for the purpose of placing the application into a more proper U.S. format. In particular, certain grammatical and idiomatic inconsistencies have been corrected by amendment to the specification, and the application is corrected for certain formalities in the originally submitted application. The present application is an English translation of an originally Korean language document. No new matter has been added by these amendments.

The Claims have been amended so as to conform with U. S. formalities.

Applicant respectfully requests that the present Amendment be entered prior to an initial Official Action on the present application.

Respectfully submitted,

11-21-03

Date

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